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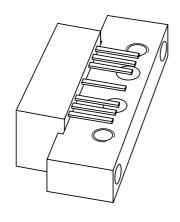






DISCRETE SEMICONDUCTORS

DATA SHEET



BGD902L 860 MHz, 18.5 dB gain power doubler amplifier

Product specification Supersedes data of 1999 Aug 17 2001 Oct 30





860 MHz, 18.5 dB gain power doubler amplifier

BGD902L

FEATURES

- · Excellent linearity
- · Extremely low noise
- Excellent return loss properties
- Silicon nitride passivation
- Rugged construction
- · Gold metallization ensures excellent reliability
- Low DC current consumption.

APPLICATIONS

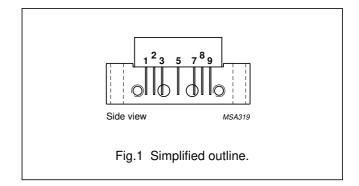
 CATV systems operating in the 40 to 900 MHz frequency range.

DESCRIPTION

Hybrid amplifier module in a SOT115J package operating with a supply voltage of 24 V.

PINNING - SOT115J

PIN	DESCRIPTION
1	input
2	common
3	common
5	+V _B
7	common
8	common
9	output



QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Gp	power gain	f = 50 MHz	18.2	18.8	dB
		f = 900 MHz	19	20	dB
I _{tot}	total current consumption (DC)	V _B = 24 V	350	380	mA

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER		MAX.	UNIT
V _B	supply voltage		30	V
Vi	RF input voltage		70	dBmV
T _{stg}	storage temperature		+100	°C
T _{mb}	operating mounting base temperature	-20	+100	°C

860 MHz, 18.5 dB gain power doubler amplifier

BGD902L

CHARACTERISTICS

Bandwidth 40 to 900 MHz; V_B = 24 V; T_{mb} = 35 °C; Z_S = Z_L = 75 $\Omega.$

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Gp	power gain	f = 50 MHz	18.2	18.5	18.8	dB
		f = 900 MHz	19	19.5	20	dB
SL	slope straight line	f = 40 to 900 MHz	0.4	0.9	1.4	dB
FL	flatness straight line	f = 40 to 900 MHz	_	±0.15	±0.3	dB
S ₁₁	input return losses	f = 40 to 80 MHz	21	24	_	dB
		f = 80 to 160 MHz	22	26	_	dB
		f = 160 to 320 MHz	22	28	_	dB
		f = 320 to 650 MHz	19	22	_	dB
		f = 650 to 900 MHz	18	21	_	dB
S ₂₂	output return losses	f = 40 to 80 MHz	25	32	_	dB
		f = 80 to 160 MHz	25	33	_	dB
		f = 160 to 320 MHz	21	29	_	dB
		f = 320 to 750 MHz	20	22	_	dB
		f = 750 to 900 MHz	19	22	_	dB
S ₂₁	phase response	f = 50 MHz	-45	_	+45	deg
СТВ	composite triple beat	49 channels flat; $V_0 = 47 \text{ dBmV}$; $f_m = 859.25 \text{ MHz}$	_	-66.5	-65	dB
		77 channels flat; $V_0 = 44 \text{ dBmV}$; $f_m = 547.25 \text{ MHz}$	_	-68	-66	dB
		110 channels flat; $V_0 = 44 \text{ dBmV}$; $f_m = 745.25 \text{ MHz}$	_	-61.5	-60	dB
		129 channels flat; $V_0 = 44 \text{ dBmV}$; $f_m = 859.25 \text{ MHz}$	_	-58	-56	dB
		110 channels; $f_m = 445.25$ MHz; $V_o = 49$ dBmV at 550 MHz; note 1	-	-62	-60	dB
		129 channels; $f_m = 697.25$ MHz; $V_o = 49.5$ dBmV at 860 MHz; note 2	_	-56	-53.5	dB
X _{mod}	cross modulation	49 channels flat; $V_0 = 47 \text{ dBmV}$; $f_m = 55.25 \text{ MHz}$	_	-64.5	-62	dB
		77 channels flat; $V_0 = 44 \text{ dBmV}$; $f_m = 55.25 \text{ MHz}$	_	-67.5	-65	dB
		110 channels flat; $V_0 = 44 \text{ dBmV}$; $f_m = 55.25 \text{ MHz}$	_	-64	-61.5	dB
		129 channels flat; $V_0 = 44 \text{ dBmV}$; $f_m = 55.25 \text{ MHz}$	_	-62.5	-60	dB
		110 channels; $f_m = 55.25$ MHz; $V_o = 49$ dBmV at 550 MHz; note 1	_	-60.5	-58	dB
		129 channels; $f_m = 859.25 \text{ MHz}$; $V_0 = 49.5 \text{ dBmV}$ at 860 MHz; note 2	_	-58	-55	dB

860 MHz, 18.5 dB gain power doubler amplifier

BGD902L

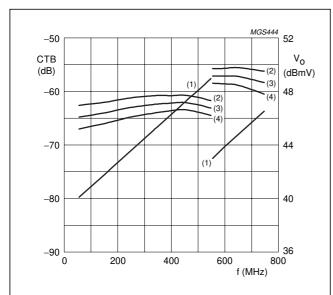
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
CSO	composite second order distortion	49 channels flat; $V_0 = 47 \text{ dBmV}$; $f_m = 860.5 \text{ MHz}$	_	-66	-63	dB
		77 channels flat; $V_0 = 44 \text{ dBmV}$; $f_m = 548.5 \text{ MHz}$	_	-71	-66	dB
		110 channels flat; $V_0 = 44 \text{ dBmV}$; $f_m = 746.5 \text{ MHz}$	_	-65	-60	dB
		129 channels flat; $V_0 = 44 \text{ dBmV}$; $f_m = 860.5 \text{ MHz}$	_	-62	-59	dB
		110 channels; $f_m = 246$ MHz; $V_o = 49$ dBmV at 550 MHz; note 1	_	-69	-64	dB
		129 channels; f _m = 246 MHz; V _o = 49.5 dBmV at 860 MHz; note 2	_	-64	-59	dB
d ₂	second order distortion	note 3	_	-80	-74	dB
		note 4	_	-83	-77	dB
		note 5	_	-84	-78	dB
Vo	output voltage	d _{im} = -60 dB; note 6	63	64.5	-	dBmV
		$d_{im} = -60 \text{ dB}$; note 7	64	65.5	_	dBmV
		d _{im} = -60 dB; note 8	66	67.5	_	dBmV
		CTB compression = 1 dB; 129 channels flat; f = 859.25 MHz	47	48	_	dBmV
		CSO compression = 1 dB; 129 channels flat; f = 860.5 MHz	49.5	51.5	_	dBmV
NF	noise figure	f = 50 MHz	_	4	5	dB
		f = 550 MHz	_	4.3	5.5	dB
		f = 750 MHz	_	5	6.5	dB
		f = 900 MHz	_	6	7.5	dB
I _{tot}	total current consumption (DC)	note 9	350	365	380	mA

Notes

- 1. Tilt = 9 dB (50 to 550 MHz); tilt = 3.5 dB at -6 dB offset (550 to 750 MHz).
- 2. Tilt = 12.5 dB (50 to 860 MHz).
- 3. $f_p = 55.25 \text{ MHz}$; $V_p = 44 \text{ dBmV}$; $f_q = 805.25 \text{ MHz}$; $V_q = 44 \text{ dBmV}$; measured at $f_p + f_q = 860.5 \text{ MHz}$.
- 4. $f_p = 55.25 \text{ MHz}$; $V_p = 44 \text{ dBmV}$; $f_q = 691.25 \text{ MHz}$; $V_q = 44 \text{ dBmV}$; measured at $f_p + f_q = 746.5 \text{ MHz}$.
- 5. $f_p = 55.25 \text{ MHz}$; $V_p = 44 \text{ dBmV}$; $f_q = 493.25 \text{ MHz}$; $V_q = 44 \text{ dBmV}$; measured at $f_p + f_q = 548.5 \text{ MHz}$.
- 6. Measured according to DIN45004B: $f_p = 851.25 \text{ MHz}; V_p = V_o; f_q = 858.25 \text{ MHz}; V_q = V_o 6 \text{ dB}; f_r = 860.25 \text{ MHz}; V_r = V_o 6 \text{ dB}; \\ \text{measured at } f_p + f_q f_r = 849.25 \text{ MHz}.$
- 7. Measured according to DIN45004B: $f_p = 740.25 \text{ MHz}; V_p = V_o; f_q = 747.25 \text{ MHz}; V_q = V_o -6 \text{ dB}; f_r = 749.25 \text{ MHz}; V_r = V_o -6 \text{ dB}; \\ \text{measured at } f_p + f_q f_r = 738.25 \text{ MHz}.$
- 8. Measured according to DIN45004B: $f_p = 540.25 \text{ MHz}; V_p = V_o; f_q = 547.25 \text{ MHz}; V_q = V_o 6 \text{ dB}; f_r = 549.25 \text{ MHz}; V_r = V_o 6 \text{ dB}; \\ \text{measured at } f_p + f_q f_r = 538.25 \text{ MHz}.$
- 9. The module normally operates at $V_B = 24 \text{ V}$, but is able to withstand supply transients up to 35 V.

860 MHz, 18.5 dB gain power doubler amplifier

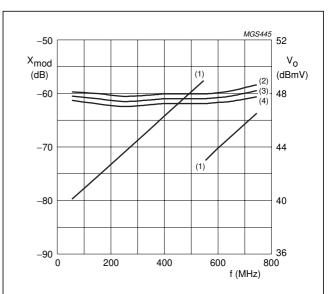
BGD902L



 $Z_S=Z_L=75~\Omega;~V_B=24~V;~110~chs;~tilt=9~dB~(50~to~550~MHz);~tilt=3.5~dB~at-6~dB~offset~(550~to~750~MHz).$

- (1) V_o.
- (3) Typ.
- (2) Typ. +3 σ.
- (4) Typ. –3 σ.

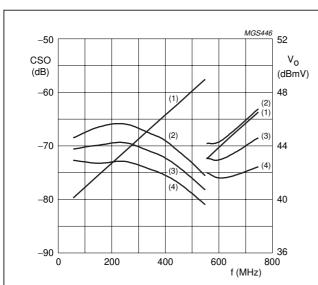
Fig.2 Composite triple beat as a function of frequency under tilted conditions.



 $Z_S=Z_L=75~\Omega;~V_B=24~V;~110~chs;~tilt=9~dB~(50~to~550~MHz);~tilt=3.5~dB~at~-6~dB~offset~(550~to~750~MHz).$

- (1) V_o.
- (3) Typ.
- (2) Typ. $+3 \sigma$.
- (4) Typ. –3 σ.

Fig.3 Cross modulation as a function of frequency under tilted conditions.



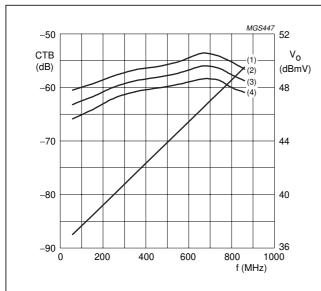
 $Z_S=Z_L=75~\Omega;~V_B=24~V;~110~chs;~tilt=9~dB~(50~to~550~MHz);~tilt=3.5~dB~at~-6~dB~offset~(550~to~750~MHz).$

- (1) V_o.
- (3) Typ.
- (2) Typ. +3 σ.
- (4) Typ. –3 σ.

Fig.4 Composite second order distortion as a function of frequency under tilted conditions.

860 MHz, 18.5 dB gain power doubler amplifier

BGD902L



 Z_S = Z_L = 75 $\Omega;\,V_B$ = 24 V; 129 chs;

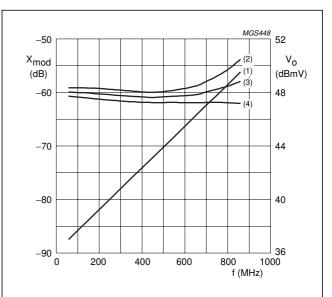
tilt = 12.5 dB; (50 to 860 MHz).

(1) V_o.

(3) Typ.

(2) Typ. +3 σ . (4) Typ. -3 σ .

Fig.5 Composite triple beat as a function of frequency under tilted conditions.



 Z_S = Z_L = 75 $\Omega;~V_B$ = 24 V; 129 chs;

tilt = 12.5 dB; (50 to 860 MHz).

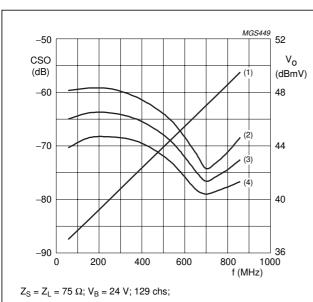
(1) V_o.

(3) Typ.

(2) Typ. +3 σ.

(4) Typ. –3 σ.

Fig.6 Cross modulation as a function of frequency under tilted conditions.



tilt = 12.5 dB; (50 to 860 MHz).

(1) V_o.

(3) Typ.

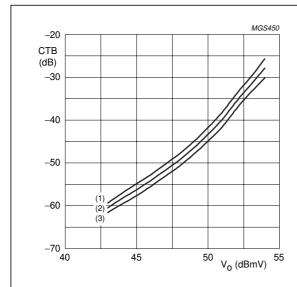
(2) Typ. +3 σ .

(4) Typ. –3 σ.

Fig.7 Composite second order distortion as a function of frequency under tilted conditions.

860 MHz, 18.5 dB gain power doubler amplifier

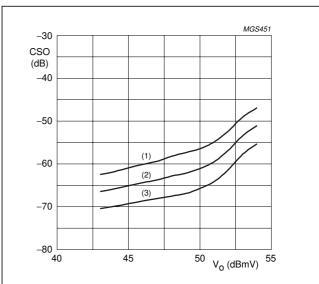
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 Z_S = Z_L = 75 $\Omega;\,V_B$ = 24 V; 129 chs; f_m = 859.25 MHz.

- (1) Typ. $+3 \sigma$.
- (2) Typ.
- (3) Typ. -3σ .

Fig.8 Composite triple beat as a function of output voltage.



 Z_S = Z_L = 75 $\Omega;\,V_B$ = 24 V; 129 chs; f_m = 860.5 MHz.

- (1) Typ. +3 σ .
- (2) Typ.
- (3) Typ. -3σ .

Fig.9 Composite second order distortion as a function of output voltage.

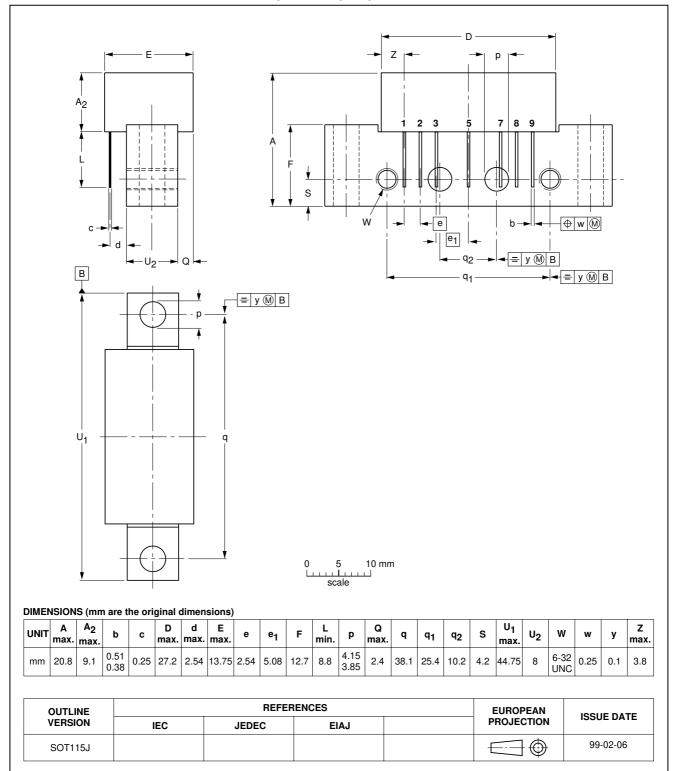
860 MHz, 18.5 dB gain power doubler amplifier

BGD902L

PACKAGE OUTLINE

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J



860 MHz, 18.5 dB gain power doubler amplifier

BGD902L

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BGD902L

NOTES

860 MHz, 18.5 dB gain power doubler amplifier

BGD902L

NOTES

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SCA73

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